FORM PTO-1595 RE	CI 01-10-2			
(Rev. 6-93) OMB No. 0651-0011 (exp. 4/94)		ratem and mademark Office		
CITE 110, 0001 0011 (CAP. 1171)				
To the Honorable Commissioner of	fPi 1019525	ached original documents or copy thereof.		
1. Name of conveying party(ies):	5/12	2. Name and address of receiving party(ies):		
Dong-Jun Kim	13102	Name: Samsung Electronics, Co., Ltd.		
Jin-Ho Kim		Windows St.		
Yong-Kyu Lee Min-Soo Cho		Internal Address:		
Eui-Youl Ryu Additional name(s) of conveying party(ies) attached?	□ Yes ⊠ No			
3. Nature of conveyance:		Street Address: 416, Maetan-dong, Paldal-gu,		
5. Nature of conveyance.		Suwon-city, Kyungki-do, Republic of Korea		
E Assissment	☐ Merger			
	□ lvjerger			
☐ Security Agreement	☐ Change of Name	City: State ZIP		
☐ Other				
	26;12/17;12/18/01:	Additional name(s) & address attached? Yes No		
4. Application number(s) or patent number	er(s):			
If this document is being filed together wi	th a new application, the exe	cution date of the application is: $\frac{11/19;20;26;12/17;12/18}{11/19;20;26;12/17;12/18}$		
A. Patent Application No.(s)		B. Patent No.(s)		
		126/26		
		10/039126		
	Additional numbers attached	!? □ Yes ⊠ No		
		6. Total number of applications and registrations		
5. Name and address of party to whom co	rrespondence concerning	involved		
document should be mailed:				
Name: Anthony P. Onello, Jr.		7. Total fee (37 CFR 3.41) \$40.00		
Internal Address MILLS & ONE	TIOIP	7. Total loc (57 el Restreyman)		
Internal Address: MILLS & ONE	IDDO EDI	☑ Enclosed		
		☐ Authorized to be charged to deposit account		
	Street Suito 605	8. Deposit Account Number:		
Street Address: Eleven Beacon	Street, Suite 605	3.23p-33-3-3-3-3-3-3-3-3-3-3-3-3-3-3-3-3-3		
City: Boston State	MA ZIP 02108	(Attach duplicate copy of this page if paying by deposit account)		
City: Boston State	-\			
01/17/2002 DBYRME 00000039 10039126	DO NOT USE	THIS SPACE		
91 FC:581 40-00	op l			
9. Statement and signature: 40.00 To the best of my knowledge and belief, the	he foregoing information is tr	ue and correct and any attached copy is a true copy of the original		
document.				
A 41 D Curalla In Dag 29 5°	72 Auti	tray P. Dell January 2, 2002		
Anthony P. Onello, Jr., Reg. 38,572 Name of Person Signing Anthony P. Onello, Jr., Reg. 38,572 Signature Signature				
Total number of page	s including cover sheet, attac	hments, and document 3		
Total number of page				

Docket No.: SAM-0203

ASSIGNMENT

We, Dong-Jun Kim, of 614-1303, Keukdong Apt., 967-2, Yongtong-dong, Paldal-ku, Suwon, kyunggi-do, Republic of Korea; Jin-Ho Kim, of 335 Elan Village, Apt. 214, San Jose, California; Yong-Kyu Lee, of 909-703, Jukong 9 Danji, Byeokjukgol, Yongtong-dong, Paldal-ku, Suwon, kyunggi-do, Republic of Korea; Min-Soo Cho, of 304-602, Hanil Apt., Hansol Town, Jungia-dong, Bundang-ku. Sungnam-shi, kyunggi-do, Republic of Korea; and Eui-Youl Ryu, of 8-503, Siyoung Apt., Hyangcheondong, Jung-ku, Daejeon-shi, Republic of Korea, having invented improvements in SEMICONDUCTOR DEVICE HAVING A FLASH MEMORY CELL AND FABRICATION METHOD THEROF described in an application for Letters Patent of the United States, executed by us on even date herewith, for good and valuable consideration, receipt of which is hereby acknowledged from Samsung Electronics Co., Ltd., a Korean corporation having a place of business at 416, Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea (and hereinafter called the Assignee, which term shall include its successors and assigns), do hereby sell, assign and transfer unto the Assignee our entire right, title, and interest in and throughout the United States of America (including its territories and dependencies) and all countries foreign thereto, in and to and under said application (which term shall include hereinafter where the context so admits all divisional, continuing, reissue and other patent applications based thereon) and the inventions (which term shall include each and every such invention, or part thereof) therein described, and any and all patents and like rights of exclusion (including extensions thereof) of any country which may be granted on or for said inventions or on said application;

And for the same consideration We do also hereby sell, assign, and transfer unto the Assignee, all our rights under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, and all other treaties of like purpose in respect of said inventions and said application, and We do hereby authorize the Assignee to apply in our name or its own name or its designee for patents and like rights of exclusion on or for said inventions in all countries, claiming (if the Assignee so desires) the priority of the filing date of said application under the provisions of said Convention, Treaty or any such other Convention or Treaty;

And for the same consideration, We do hereby agree for ourselves and for our heirs, executors, and administrators, promptly upon request of the Assignee to execute and deliver without further compensation any power of attorney, assignment, original, divisional, continuing, reissue or other application or applications for patent or patents or like rights of exclusion of any country, or other lawful documents and any further assurances that may be deemed necessary or desirable by the Assignee, fully to secure to it said right, title, and interest as aforesaid in and to said inventions, applications, and said several patents and like rights of exclusion (including extensions thereof) or any of them, all, however, at the expense of the Assignee, its successors, or assigns;

And We do hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America and the corresponding Official of each country foreign thereto to issue to the Assignee, any and all patents and like rights of exclusion which may be granted in any country upon said United States application on or for said inventions;

And We do hereby covenant for ourselves and our legal representatives and agree with the Assignee, that We have granted no right or license to make, use, or sell said inventions to anyone except the Assignee, that prior to the execution of this deed our right, title, and interest in and to said inventions has not been otherwise encumbered by us, and that We have not executed and will not execute any instruments in conflict herewith.

First or Sole Inventor:				
Signature:	Dong-Jun Kim	Date:		
Second Joint Inventor: Signature:	Jin-Ho Kim	Date: 12/17/41		
Third Joint Inventor:				
Signature:	Yong-Kyu Lee	Date:		
Fourth Joint Inventor:				
Signature:	Min-Soo Cho	Date:		
Fifth Joint Inventor:				
Signature:	Eui-Youl Ryu	Date:		

DOCKET NO. SAM-0203 J:\SAM\0203\assignment2.wpd

> PATENT REEL: 012466 FRAME: 0188

Docket No.: SAM-0203

ASSIGNMENT

We, Dong-Jun Kim, of 614-1303, Keukdong Apt., 967-2, Yongtong-dong, Paldal-ku, Suwon, kyunggi-do, Republic of Korea; Jin-Ho Kim, of 335 Elan Village, Apt. 214, San Jose, California; Yong-Kyu Lee, of 909-703, Jukong 9 Danji, Byeokjukgol, Yongtong-dong, Paldal-ku, Suwon, kyunggi-do, Republic of Korea, Min-Soo Cho, of 304-602, Hanil Apt., Hansol Town, Jungja-dong, Bundang-ku, Sungnam-shi, kyunggi-do, Republic of Korea; and Eui-Youl Ryu, of 8-503, Siyoung Apt., Jungchondong, Jung-ku, Daejeon-shi, Republic of Korea, having invented improvements in SEMICONDUCTOR DEVICE HAVING A FLASH MEMORY CELL AND FABRICATION METHOD THEROF described in an application for Letters Patent of the United States, executed by us on even date herewith, for good and valuable consideration, receipt of which is hereby acknowledged from Samsung Electronics Co., Ltd., a Korean corporation having a place of business at 416, Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea (and hereinafter called the Assignee, which term shall include its successors and assigns), do hereby sell, assign and transfer unto the Assignee our entire right, title, and interest in and throughout the United States of America (including its territories and dependencies) and all countries foreign thereto, in and to and under said application (which term shall include hereinafter where the context so admits all divisional, continuing, reissue and other patent applications based thereon) and the inventions (which term shall include each and every such invention, or part thereof) therein described, and any and all patents and like rights of exclusion (including extensions thereof) of any country which may be granted on or for said inventions or on said application;

And for the same consideration We do also hereby sell, assign, and transfer unto the Assignee, all our rights under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, and all other treaties of like purpose in respect of said inventions and said application, and We do hereby authorize the Assignee to apply in our name or its own name or its designee for patents and like rights of exclusion on or for said inventions in all countries, claiming (if the Assignee so desires) the priority of the filing date of said application under the provisions of said Convention, Treaty or any such other Convention or Treaty;

And for the same consideration, We do hereby agree for ourselves and for our heirs, executors, and administrators, promptly upon request of the Assignee to execute and deliver without further compensation any power of attorney, assignment, original, divisional, continuing, reissue or other application or applications for patent or patents or like rights of exclusion of any country, or other lawful documents and any further assurances that may be deemed necessary or desirable by the Assignee, fully to secure to it said right, title, and interest as aforesaid in and to said inventions, applications, and said several patents and like rights of exclusion (including extensions thereof) or any of them, all, however, at the expense of the Assignee, its successors, or assigns:

And We do hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America and the corresponding Official of each country foreign thereto to issue to the Assignce, any and all patents and like rights of exclusion which may be granted in any country upon said United States application on or for said inventions;

And We do hereby covenant for ourselves and our legal representatives and agree with the Assignee, that We have granted no right or license to make, use, or sell said inventions to anyone except the Assignee, that prior to the execution of this deed our right, title, and interest in and to said inventions has not been otherwise encumbered by us, and that We have not executed and will not execute any instruments in conflict herewith.

First or Sole Inventor:					
Signature:	Dong-Jun Kim	Date:			
Second Joint Inventor:					
Signature:	Jin-Ho Kim	Date:			
Third Joint Inventor:					
Signature:	Yong-Kyu Lee	Date:			
Fourth Joint Inventor:					
Signature:	Min-Soo Cho	Date:			
Fifth Joint Inventor:					
Signature:	Eui-You Ryu	Date: December 18th, 2001			

DOCKET NO. SAM-0203 J:\SAM\0203\esignment3.wpd





Docket No.: SAM-0203

ASSIGNMENT

We, Dong-Jun Kim, of 614-1303, Keukdong Apt., 967-2, Yongtong-dong, Paldal-ku, Suwon, kyunggi-do, Republic of Korea; Jin-Ho Kim, of 101-1006, Daerim Apt., Dokok-dong, Kangnam-ku, Seoul, Republic of Korea; Yong-Kyu Lee, of 909-703, Jukong 9 Danji, Byeokjukgol, Yongtong-dong, Paldal-ku, Suwon, kyunggi-do, Republic of Korea; Min-Soo Cho, of 304-602, Hanil Apt., Hansol Town, Jungja-dong, Bundang-ku, Sungnam-shi, kyunggi-do, Republic of Korea; and Eui-Youl Ryu, of 8-503, Siyoung Apt., Hyangcheon-dong, Jung-ku, Daejeon-shi, Republic of Korea, having invented improvements in SEMICONDUCTOR DEVICE HAVING A FLASH MEMORY CELL AND FABRICATION METHOD THEROF described in an application for Letters Patent of the United States, executed by us on even date herewith, for good and valuable consideration, receipt of which is hereby acknowledged from Samsung Electronics Co., Ltd., a Korean corporation having a place of business at 416, Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea (and hereinafter called the Assignee, which term shall include its successors and assigns), do hereby sell, assign and transfer unto the Assignee our entire right, title, and interest in and throughout the United States of America (including its territories and dependencies) and all countries foreign thereto, in and to and under said application (which term shall include hereinafter where the context so admits all divisional, continuing, reissue and other patent applications based thereon) and the inventions (which term shall include each and every such invention, or part thereof) therein described, and any and all patents and like rights of exclusion (including extensions thereof) of any country which may be granted on or for said inventions or on said application;

And for the same consideration We do also hereby sell, assign, and transfer unto the Assignee, all our rights under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, and all other treaties of like purpose in respect of said inventions and said application, and We do hereby authorize the Assignee to apply in our name or its own name or its designee for patents and like rights of exclusion on or for said inventions in all countries, claiming (if the Assignee so desires) the priority of the filing date of said application under the provisions of said Convention, Treaty or any such other Convention or Treaty;

And for the same consideration, We do hereby agree for ourselves and for our heirs, executors, and administrators, promptly upon request of the Assignee to execute and deliver without further compensation any power of attorney, assignment, original, divisional, continuing, reissue or other application or applications for patent or patents or like rights of exclusion of any country, or other lawful documents and any further assurances that may be deemed necessary or desirable by the Assignee, fully to secure to it said right, title, and interest as aforesaid in and to said inventions, applications, and said several patents and like rights of exclusion (including extensions thereof) or any of them, all, however, at the expense of the Assignee, its successors, or assigns;

And We do hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America and the corresponding Official of each country foreign thereto to issue to the Assignee, any and all patents and like rights of exclusion which may be granted in any country upon said United States application on or for said inventions;

-1-

And We do hereby covenant for ourselves and our legal representatives and agree with the Assignee, that We have granted no right or license to make, use, or sell said inventions to anyone except the Assignee, that prior to the execution of this deed our right, title, and interest in and to said inventions has not been otherwise encumbered by us, and that We have not executed and will not execute any instruments in conflict herewith.

First or Sole Inve	entor: Signature:	Hong Jun Kim Dong-Jun Kim	Date: NoVnhr >0, >>>1
Second Joint Inv	entor: Signature:	Jin-Ho Kim	Date:
Third Joint Inver		Yong-Kyu Lee	Date: November 26 mg
Fourth Joint Inve	entor: Signature:	Cho. Min Soo Min-Soo Cho	Date: November 19. 200)
Fifth Joint Invent	tor: Signature:	 בעו-Youl Ryu	Date:

DOCKET NO. SAM-0203 J\SAM\0203\assignment wpd

RECORDED: 01/03/2002

PATENT REEL: 012466 FRAME: 0192